Sipex	CHANGE NOTICE
PART NUMBER(S):	PCN No.: 06-0130-01
Please see attachment.	DATE: January 30, 2006
PART DESCRIPTION:	<u>'</u>
Power Management and Interface Products	s – Change in Wafer Fabrication Site
LEVEL OF CHANGE:	
[X] Level I, Customer Approval.	[ ] Level II, Customer Information.
PRODUCT ATTRIBUTE AFFECTED:	
[ ] Material Change [ ] Design Change [ <b>X</b> ] Process Change	<ul><li>[ ] Data Sheet Change</li><li>[ ] Package Change</li><li>[ ] Packing / Shipping</li></ul>
[X] Other, Explain: Wafer Fabricatio	n Site Transfer
DESCRIPTION OF CHANGE:  Announcing transfer of certain Power Manager facility to wafer foundry Silan. See attached Pr	ment and Interface Products from Hillview wafer fabrication roduct List no. 01.
REASON FOR CHANGE:	
	ts as listed are being transferred to external wafer the Sipex Hillview Wafer Fabrication manufacturing site.
FABRICATION PROCESS QUALIFICATION COMPLETED (DATE): May 28, 2006	PRODUCT CHARACTERIZATION COMPLETED: June 18, 2006 SAMPLES* AVAILABLE (DATE): June 11, 2006

<sup>\*</sup> Samples representative of product from the Product Family being transferred.



PRODUCT CHANGE NOTICE					
EARLIEST DATE OF PRODUC SHIPMENTS: October 16, 200	_				
EFFECTIVITY CHANGE DATE	OR DATE CODE: Work we	ek associated with earliest	production shipment.		
[ ] STANDARD DISTRIBUT	ION	[х] сизтом	DISTRIBUTION		
PERSON TO CONTACT WITH	QUESTIONS:				
Fred Claussen					
VP Quality Assurance and Relia Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	ability				



## PRODUCT CHANGE NOTICE

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## List 1

SP3238CA SP3238CA-L SP3238CY SP3238CY-L SP3238EA SP3238EA-L SP3238ECA SP3238ECA-L SP3238ECY	SP3238ECY-L SP3238EEA SP3238EEA-L SP3238EEY SP3238EEY-L SP3238EY-L SP3239CA SP3239CA-L	SP3239CY SP3239CY-L SP3239EA SP3239EA-L SP3239ECA SP3239ECY SP3239ECY SP3239ECY-L SP3239EEA	SP3239EEA-L SP3239EEY SP3239EEY-L SP3239EY SP3239EY-L
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